

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE15H15T uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in Automotive applications and a wide variety of other applications.

General Features

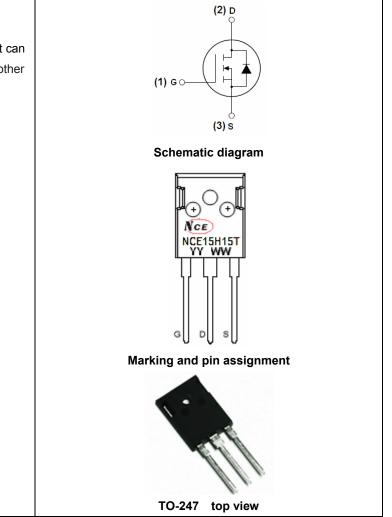
- $V_{DSS} = 150V, I_D = 150A$ $R_{DS(ON)} < 8m\Omega @ V_{GS} = 10V$ (Typ: 6.6 m Ω)
- Good stability and uniformity with high E_{AS}
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Application

- Automotive applications
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE15H15T	NCE15H15T	TO-247	-	-	-

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDSS	150	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	150	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	106	А
Pulsed Drain Current	I _{DM}	600	А
Maximum Power Dissipation	PD	460	W
Derating factor		3.07	W/℃
Single pulse avalanche energy (Note 3)	E _{AS}	3100	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	18.5	V/ns



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Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C

Thermal Characteristic

	Thermal Resistance, Junction-to-Case (Note 1)	R _{θJC}	0.33	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Мах	Unit
Off Characteristics	ł					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	150	170	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =150V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±200	nA
On Characteristics	· · ·					
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I _D =40A	-	6.6	8	mΩ
Forward Transconductance	g fs	V _{DS} =50V,I _D =40A	150	-	_	S
Dynamic Characteristics						
Input Capacitance	C _{lss}		-	21000	-	PF
Output Capacitance	C _{oss}	V _{DS} =25V,V _{GS} =0V, F=1.0MHz		1446	-	PF
Reverse Transfer Capacitance	C _{rss}			1120	-	PF
Switching Characteristics						
Turn-on Delay Time	t _{d(on)}		-	20	-	nS
Turn-on Rise Time	tr	V_{DD} =30V,I _D =2A,R _L =15 Ω	-	110	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =2.5 Ω		45	-	nS
Turn-Off Fall Time	t _f		-	70	-	nS
Total Gate Charge	Qg	V_{DS} =30V,I _D =30A	-	586	-	nC
Gate-Source Charge	Q _{gs}	V _{GS} =10V		123	-	nC
Gate-Drain Charge	Q _{gd}		-	184	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =40A	-	-	1.2	V
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 75A	-	71	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note2)	-	106	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

1. Surface Mounted on FR4 Board, t \leq 10 sec.

2. Pulse Test: Pulse Width ≤ 400 μ s, Duty Cycle ≤ 2%.

3. EAS condition: Tj=25 $^\circ C, V_{DD}$ =75V, V_G=10V, L=0.5mH, Rg=25 Ω



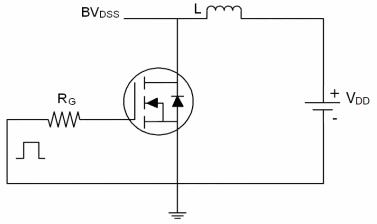
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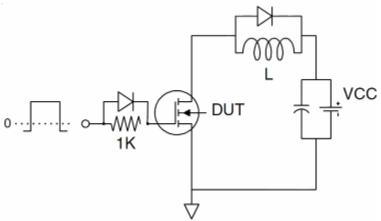


Test circuit

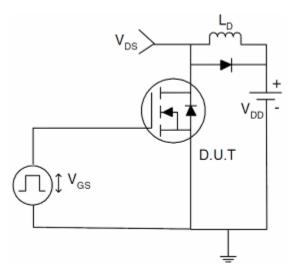




2) Gate charge test Circuit:



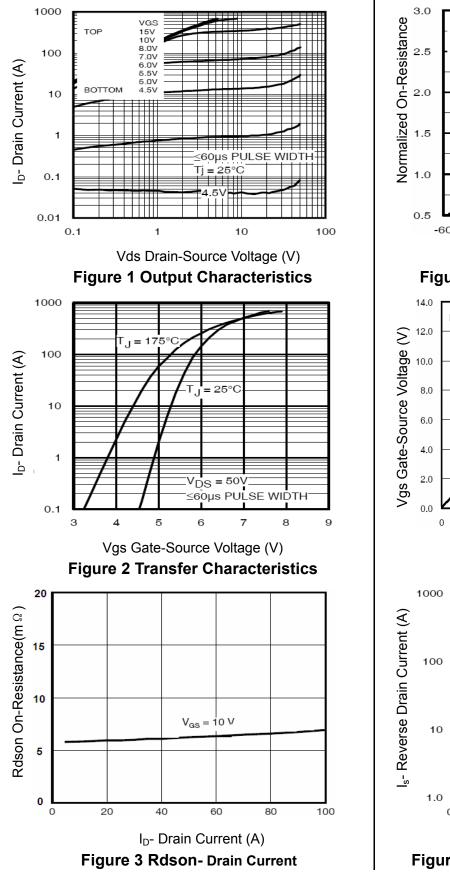
3) Switch Time Test Circuit:

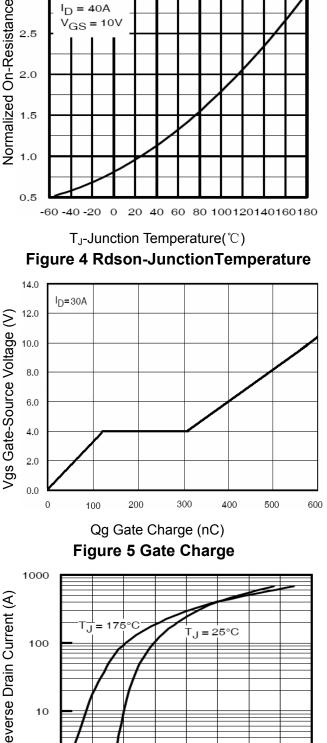






Typical Electrical and Thermal Characteristics





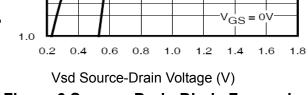


Figure 6 Source- Drain Diode Forward



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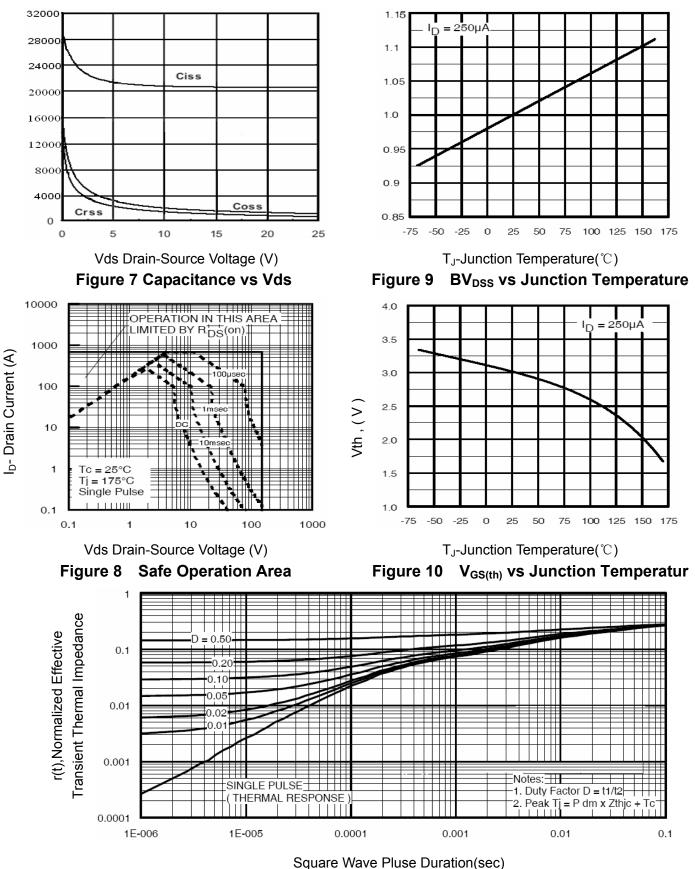


Figure 11 Normalized Maximum Transient Thermal Impedance

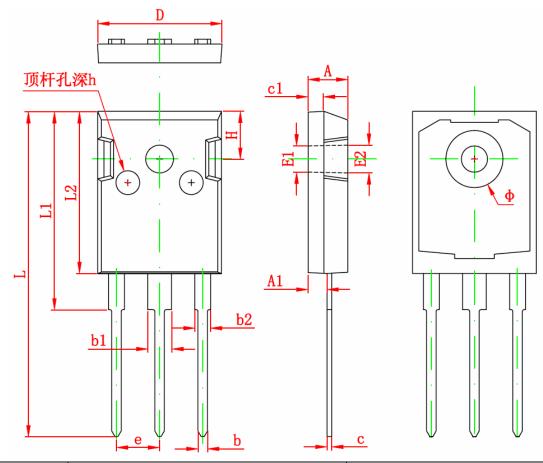


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TO-247 Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	4.850	5.150	0.191	0.200	
A1	2.200	2.600	0.087	0.102	
b	1.000	1.400	0.039	0.055	
b1	2.800	3.200	0.110	0.126	
b2	1.800	2.200	0.071	0.087	
c	0.500	0.700	0.020	0.028	
c1	1.900	2.100	0.075	0.083	
D	15.450	15.750	0.608	0.620	
E1	3.500REF		0.138REF		
E2	3.600REF		0.142REF		
L	40.900	41.300	1.610	1.626	
L1	24.800	25.100	0.976	0.988	
L2	20.300	20.600	0.799	0.811	
Φ	7.100	7.300	0.280	0.287	
e	5.450TYP		0.215TYP		
Н	5.980TYP		0.235 REF		
h	0.000	0.300	0.000	0.012	







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